PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Jeong Won OH	10/19/2009
Mi Sook KIM	10/19/2009
Jin Reol KIM	10/19/2009
Se Ho AHN	10/19/2009
Chi Woo LEE	10/19/2009
Ho Min JEON	10/19/2009
Tae Ohk CHAE	10/19/2009

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12612303

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: P3014US00

501040184 REEL: 023648 FRAME: 0232

P \$40.00 12612303

PATENT

NAME OF SUBMITTER:	Hae-Chan Park
Total Attachments: 4 source=P3014US00_Assignment#page1.tif source=P3014US00_Assignment#page2.tif source=P3014US00_Assignment#page3.tif source=P3014US00_Assignment#page4.tif	

PATENT REEL: 023648 FRAME: 0233

Attorney's Docket No.: P3014US00



ASSIGNMENT

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in

APPA	⊠ RATUS	an applicatio	n for United States L D FOR USER INTERFA	etters Patent er	ntitled USER DEVICE ("App	INTERFA	ACE
issued	☐ ("Pater	upon which Unt");	nited States Letters Pat	ent, Patent Numb	Der	Modern Bankhala ka Kisa ki Akusiya qogg	has
	Where	as, Assignor d	esires to convey all righ	ts, titles, and inte	rests in and to	the same	e to:
			PANTECH CO., LTD. Pantech R&D Center, I Mapo-gu Seoul 121-270 Republic of Korea	l-2, DMC Sangan	n-dong,		

PANTECH CO., LTD. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.



IN WITNESS WHEREOF, Assignor has hereunto set hand and seal.

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RECORDED: 12/14/2009

Date:

2009. 10.19

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